

Notice of References Cited	Application/Control No. 10/734,593	Applicant(s)/Patent Under Reexamination KUNDALGURKI, SRIVATSA	
	Examiner Evan Pert	Art Unit 2826	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	B	US-6,562,700	05-2003	Gu et al.	438/477
	C	US-6,492,272	12-2002	Okada et al.	438/690
	D	US-6,030,901	02-2000	Hopper et al.	438/711
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	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	K. R. Williams et al., "Etch Rates for Micromachining Processing - Part II" December 2003, Vol. 12, Issue 6, pages 761-778.
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.